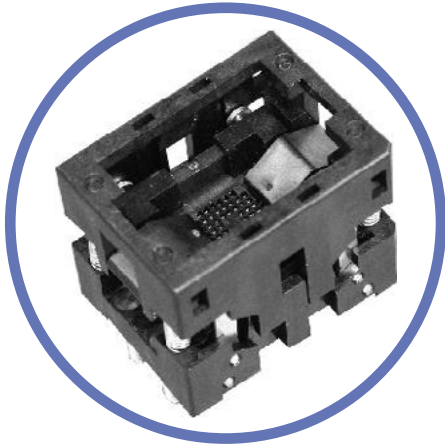


## | 775E SERIES

COMPACT CSP/FBGA



### Features

- 0.8mm Pitch
- Compression surface mount
- Z-axis compliant "U" shaped contact supports a wide variety of solder ball shape and composition
- Compact outline and low actuation force achieved through use of innovative latching mechanism
- Field exchangeable IC guide

### MATERIALS & SPECIFICATIONS

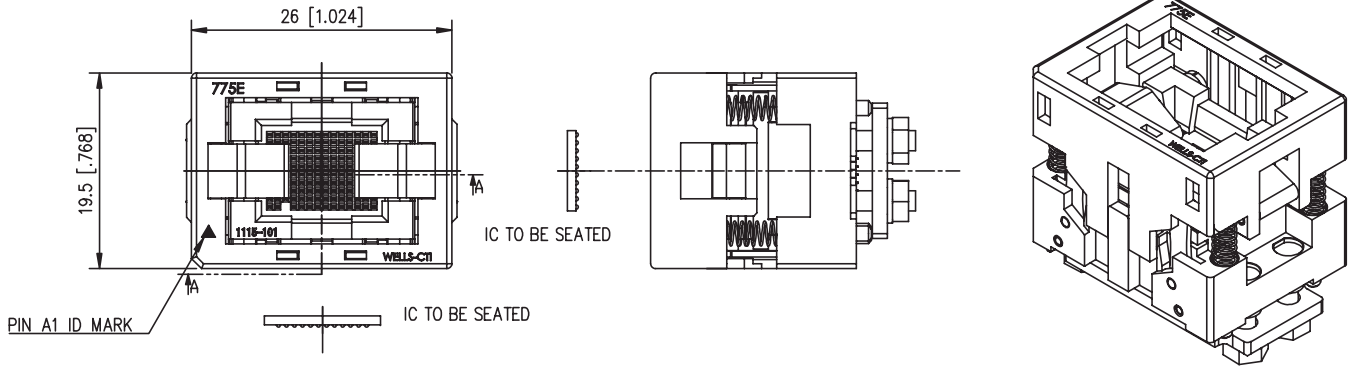
<b>Body Materials</b>	PES, PEI, LCP, or Equivalent
<b>Contact Material</b>	Beryllium Copper Alloy
<b>Contact Plating</b>	Gold
<b>Contact Force</b>	13 Gram Average
<b>Contact Resistance</b>	200~300 mΩ
<b>Temperature Rating</b>	150°C
<b>Durability</b>	10,000 Cycles min.

Pitch e (mm)	Pin Count	Package Size (mm)	Pin Matrix.	Ball Dia. (mm)	Ball Height (mm)	Part Number
0.8	60	8X11.6	8X10	0.40	0.22	775E1060-101
	84	9X12	10X12	0.40	0.15	775E1084-101
	115	9X12	10X14	0.40	0.15	775E1115-101
	115	11X13	10X14	0.40	0.22	775E1115-102
	137	11X13	10X14	0.40	0.15	775E1137-101
	138	10X10	12X12	12X12	0.40	0.22



# DIMENSIONS AND DIAGRAMS

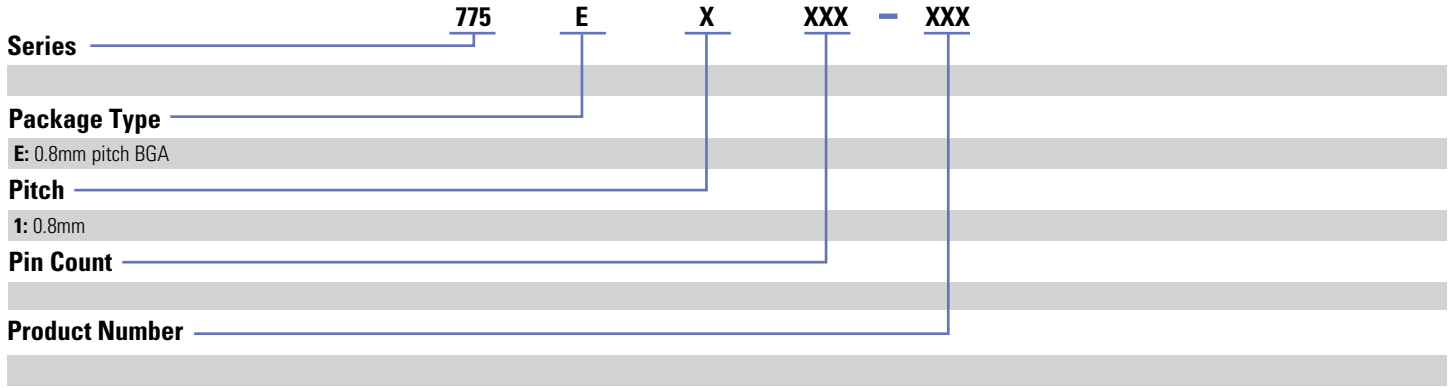
Dimensions in mm (Inches)





## DESCRIPTION & ORDERING INFO

Example : 775 E X XXX-XXX



Revised 02/06/18

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